



GOMACTech-19

“Artificial Intelligence & Cyber Security: Challenges and Opportunities for the Government”

Albuquerque Convention Center, Albuquerque, NM
25-28 March 2019

Call for Papers

GOMACTech was established primarily to report on developments in microcircuit technologies and applications for government systems. Established in 1968, the conference has focused on advances in systems and technologies being developed by the Department of Defense and other government agencies, and has been used to announce major government microelectronics initiatives and provides a forum for government reviews. GOMACTech-19 features plenary sessions addressing the role of microelectronics in Cyber Security and Artificial Intelligence opportunities for the government as well as, a technical program describing the latest technological advances in the field, including trustworthy components/technologies, Electro-Optical components, RF components, Micro-Nano electronics, electronics integration, and electronics materials, emerging neuromorphic electronics, quantum information/sensing technologies and technologies beyond Moore’s law, advances in wide and ultrawide-bandgap material and device development, and novel power distribution architectures. Abstracts are solicited in the topic areas listed below. Detailed descriptions of the technical topic areas can be found [here](#). GOMACTech is the premier forum for reporting on government funded microcircuit research and other research efforts that focus on the technology needs of government systems. It is an unclassified, export controlled event. All registrants must provide proof of U.S. citizenship or permanent residence status and sign a non-disclosure statement prior to being permitted entry into the conference. Authors whose abstract is accepted (oral and poster presentations) are expected to produce a paper for the conference proceedings.

Technical Topic Areas

Radiation Hardened Technologies, Designs & Systems

Cyber Security Technologies

Trusted and Assured Microelectronics

RF Technologies, Components and Systems

EO/IR Technologies, Components and Systems

Photonic Technologies, Components and Systems

Power Electronics & Emerging Power Technologies

Packaging, Integration, Thermal and Control Technologies

Emerging Technologies (Quantum, Neuromorphic, Flexible Electronics, IC’s beyond Moore’s law...)

Advanced Materials and Processes

• Electronic Abstracts Due - EXTENDED	September 28, 2018
• Author Notification of Acceptance	November 2, 2018
• Final Paper Due	January 11, 2019

Travis Anderson, General Chair
U.S. Naval Research Laboratory
travis.anderson@nrl.navy.mil

Pauline Paki, Technical Chair
Defense Threat Reduction Agency
pauline.f.paki.civ@mail.mil

